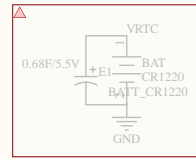
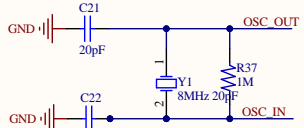
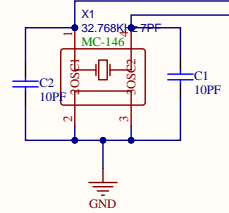
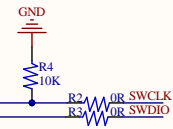
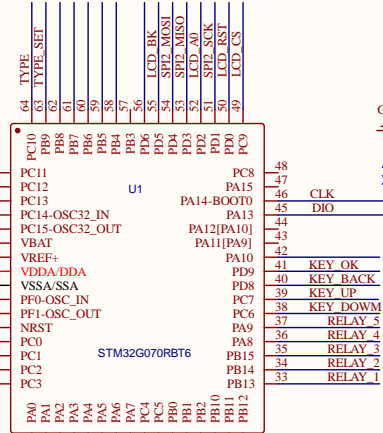
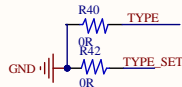


MCU

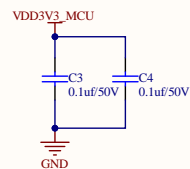
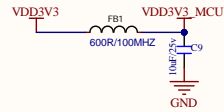
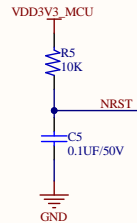
pin 63 64软件设置弱上拉
pin63 pin64 悬空, 设备类型为4IO(ACSTATION)
pin63 接地, pin64悬空, 表示12IO
pin63 悬空, pin64接地, 表示2IO
pin63 接地, pin64接地, 表示4IO



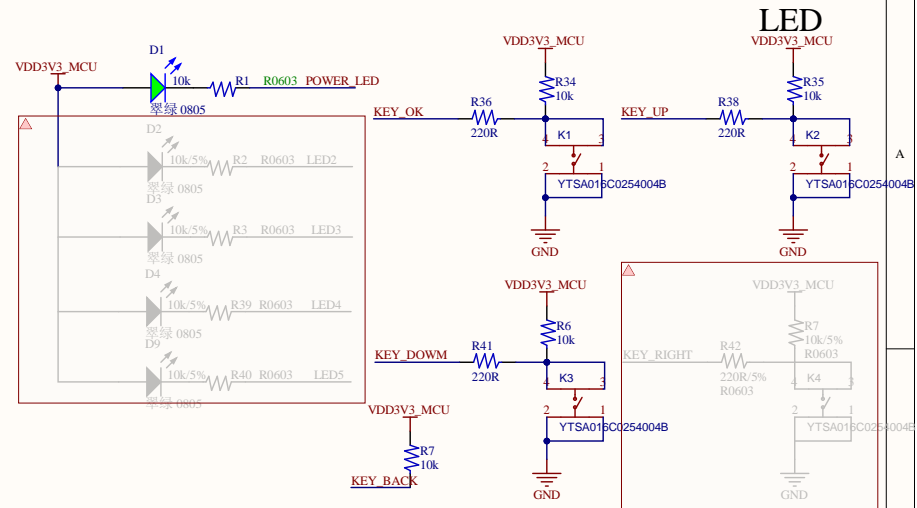
软件升级



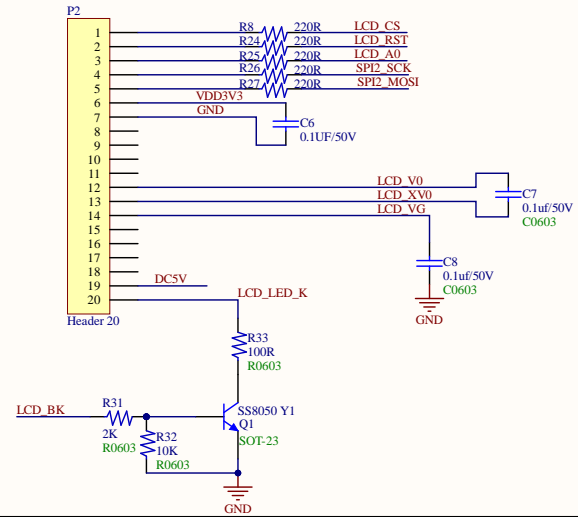
调试串口



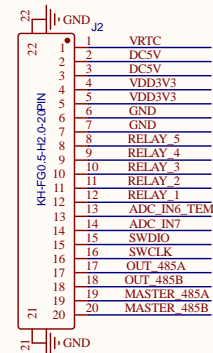
RELAY_1 PB13 (W)
RELAY_2 PB14 (Y)
RELAY_3 PB15 (G)
RELAY_4 PA8 (W2)
RELAY_5 PA9 (Y2)
KEY_OK PD9
KEY_UP PC7
KEY_DOWM PC6
ADC_IN6 PA4 NTC温度采集
ADC_IN7 PA7 (暂时不用)



DISPLAY

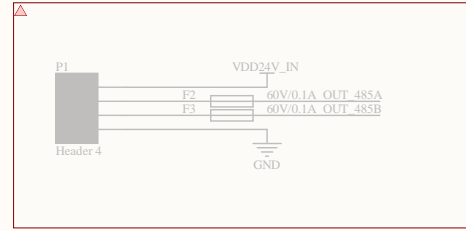
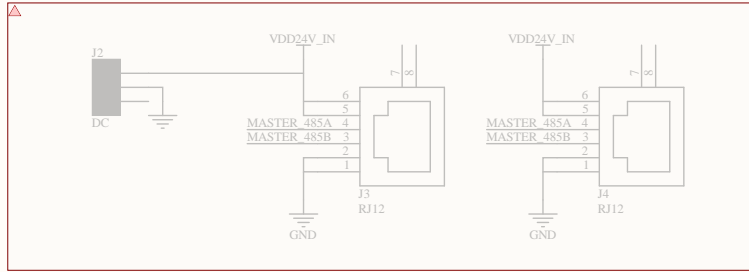


BBL LOGO
ESD LOGO
MARK

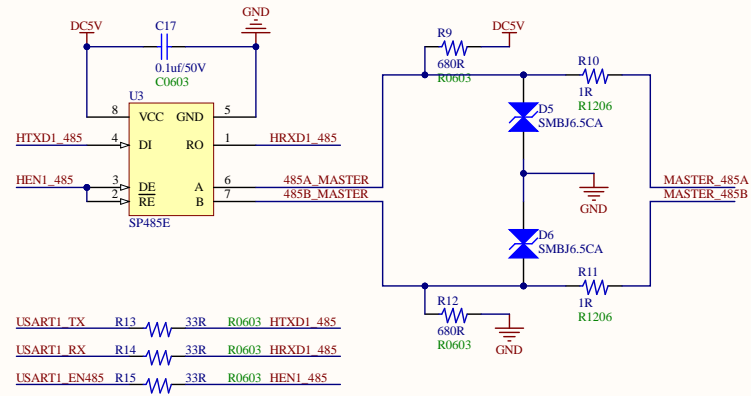


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Date:	8/22/2023	Sheet of
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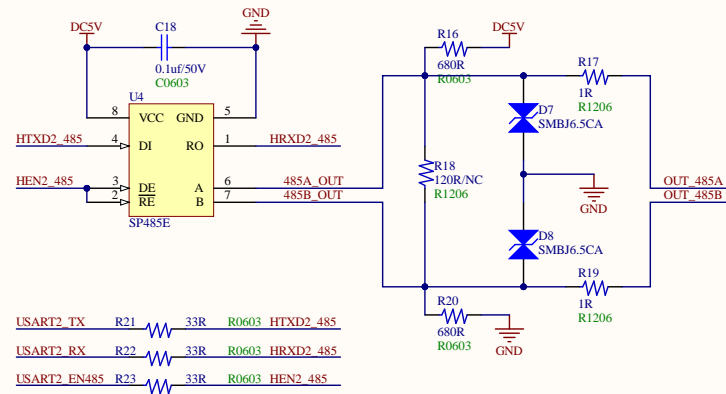
RJ12_IN&OUT



MASTER_485



OUT_485



Title		
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Date: 8/22/2023	Sheet of	
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